

## IGBT

#### Features

- 1200V,25A
- V<sub>CE(sat)(typ.)</sub>=1.9V@V<sub>GE</sub>=15V,I<sub>C</sub>=25A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA

#### **General Description**

**Absolute Maximum Ratings** 

JIAEN FS-IGBTs offer lower losses and higher energy efficiency for application such as IH (induction heating),UPS, general inverter and other soft switching applications.

# Symbol 2.Collector 1.Gate 3.Emitter TO-247 G C E

Symbol	Parameter	Value	Units	
VCES	Collector-Emitter Voltage	1200	V	
VGES	Gate-Emitter Voltage	<u>+</u> 30	V	
	Continuous Collector Current ( Tc=25 $^{\circ}$ C)	50	А	
lc	Continuous Collector Current (Tc=100°C)	25	А	
Ісм	Pulsed Collector Current (Note 1)	75	А	
IF	Diode Continuous Forward Current ( $T_c=100$ $^{\circ}C$ )	25	A	
IFM	Diode Maximum Forward Current (Note 1)	75	А	
t <sub>sc</sub>	Short Circuit Withstand Time	10	us	
PD	Maximum Power Dissipation ( T <sub>c</sub> =25 $^{\circ}$ C)	318	W	
	Maximum Power Dissipation ( $T_{C}\text{=}100^{\circ}\text{C}$ )	159	W	
TJ	Operating Junction Temperature Range	-55 to +175	°C	
Tstg	Storage Temperature Range	-55 to +150	°C	

#### **Thermal Characteristics**

Symbol	Parameter	Max.	Units
Rth j-c Thermal Resistance, Junction to case for IGBT		0.47	°C/ W
R <sub>th j-c</sub> Thermal Resistance, Junction to case for Diode 1.5		°C/W	
R <sub>th j-a</sub>	Thermal Resistance, Junction to Ambient	40	°C/ W



#### **Electrical Characteristics** (Tc=25 $^{\circ}$ C unless otherwise noted )

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 250uA	1200	-	-	V
I <sub>CES</sub>	Collector-Emitter Leakage Current	V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0V	-	-	100	uA
I <sub>GES</sub>	Gate Leakage Current, Forward	$V_{GE} = + 30V, V_{CE} = 0V$	-	-	<u>+</u> 100	nA
V <sub>GE(th)</sub>	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 250 \text{uA}$	4.5	-	6.5	V
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	V <sub>GE</sub> =15V, I <sub>C</sub> = 25A	-	1.9		V
Qg	Total Gate Charge	Vcc=960V	-	112		nC
Qge	Gate-Emitter Charge	V <sub>GE</sub> =15V	-	33.6		nC
Qgc	Gate-Collector Charge	IC=25A	-	61.9		nC
t d(on)	Turn-on Delay Time	$V_{cc}=600V$ $V_{GE}=15V$ $I_{c}=25A$ $R_{G}=15\Omega$ Inductive Load $T_{c}=25\ ^{\circ}C$	-	32	-	ns
t r	Turn-on Rise Time		-	42	-	ns
t d(off)	Turn-off Delay Time		-	200	-	ns
t f	Turn-off Fall Time		-	95	-	ns
Eon	Turn-on Switching Loss		-	1.5	-	mJ
Eoff	Turn-off Switching Loss		-	0.9	-	mJ
Ets	Total Switching Loss		-	2.4	-	mJ
Cies	Input Capacitance	– V <sub>CE</sub> =25V V <sub>GE</sub> =0V f = 1MHz	-	2286	-	pF
Coes	Output Capacitance		-	120	-	pF
Cres	Reverse Transfer Capacitance		-	26	-	pF

#### Electrical Characteristics of Diode (Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V <sub>F</sub>	Diode Forward Voltage	I <sub>F</sub> =25A	-	2.2	2.8	V
trr	Diode Reverse Recovery Time	V <sub>CE</sub> = 600V	-	328		ns
l r r	Diode peak Reverse Recovery Current	I <sub>F</sub> = 25A	-	18		A
Qr r	Diode Reverse Recovery Charge	dIF/dt = 700A/us	-	1760		nC

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



#### **Typical Performance Characteristics**

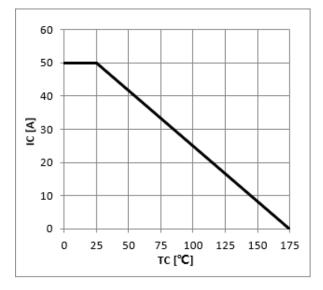


Figure 1: Maximum DC Collector Current VS. case temprature

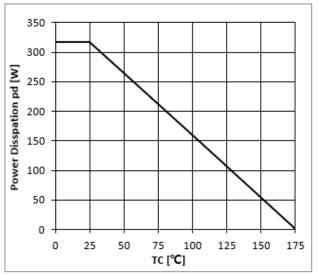


Figure 2: Power Dissipation VS. Case Temperature

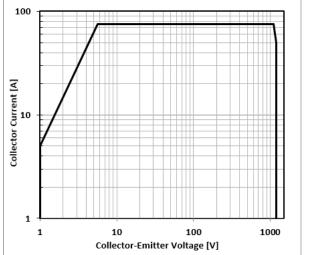


Figure 3: Reverse Bias SOA,TJ=125 $^\circ\!\mathrm{C}$ ,VGE=15V

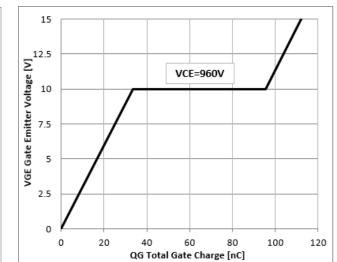
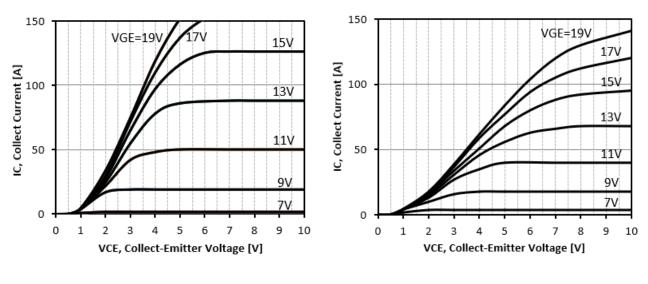
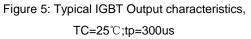
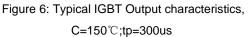


Figure 4: Typical Gate charge VS. VGE,IC=25A









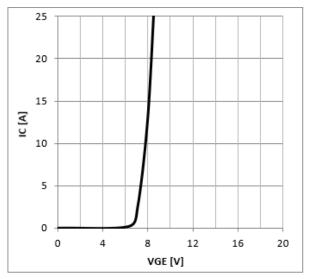


Figure 7: Typical Gate Threshold Voltage

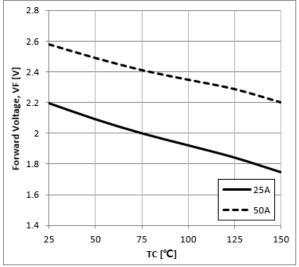


Figure 8: Typical Forward Voltage vs IF



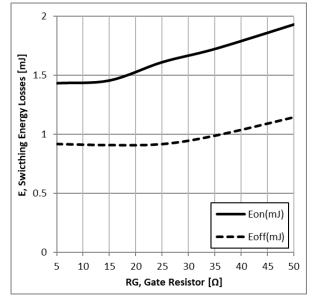


Figure 9: Typical Energy Loss VS. RG, TC=25℃, L=200uH,VCE=600V,VGE=15V,IC=25A

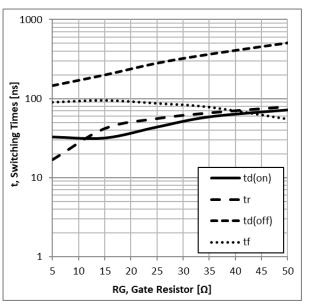


Figure 10: Typical Switching Time VS. RG, TC=25 $^\circ\!\mathrm{C}$ , L=200uH,VCE=600V,VGE=15V,IC=25A

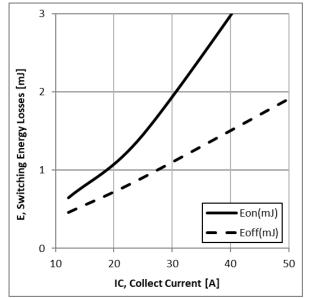


Figure 11: Typical Energy Loss VS. IC,TC=25 $^{\circ}$ C, L=200uH,VCE=600V, VGE=15V,RG=15 $^{\Omega}$ 

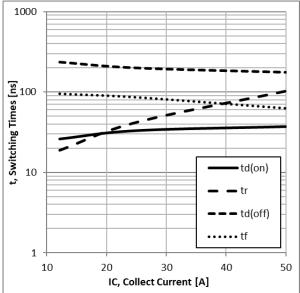


Figure 12: Typical Switching Time VS. IC,TC=25 $^\circ\!C$ , L=200uH,VCE=600V,VGE=15V,RG=15 $\Omega$ 



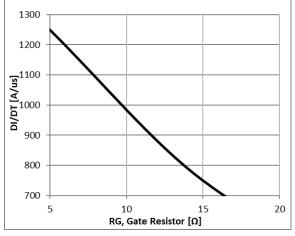
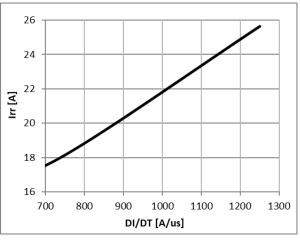
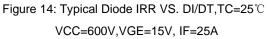
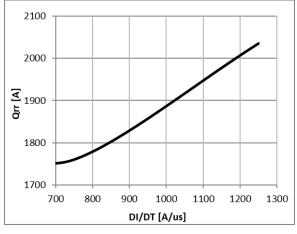
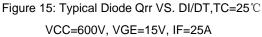


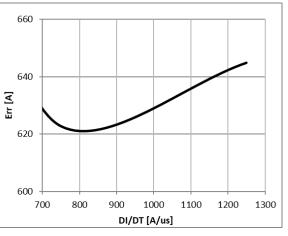
Figure 13: Typical Diode DI/DT VS. RG,TC=25°C VCC=600V, VGE=15V, IF=25A

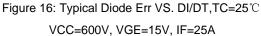














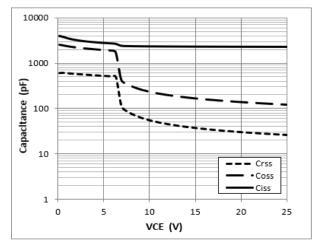


Figure 17: Typical Capacitance VS. VCE, VGE=0V,f=1MHz

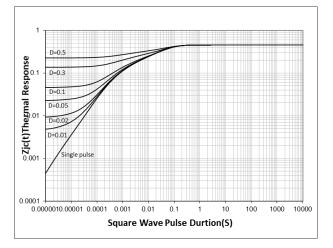
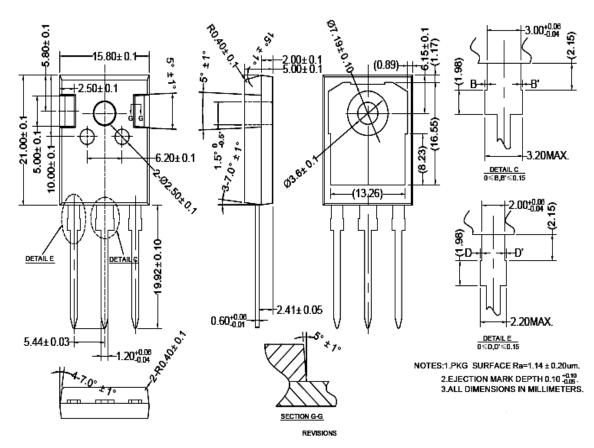


Figure 18: Normalized transient thermal impedance junction-to-case



#### **TO247 PACKAGE OUTLINE**



公差值	表面粗糙度
±0.2	Ra3.2~6.3
±0.1	Ra1.6~3.2
±0.01	Ra0.8~1.6
±0.005	Ra0.4~0.8
±0.002	Ra0.2~0.4
	±0.2 ±0.1 ±0.01 ±0.005

0≤D,D'≤0.15

NOTES:1.PKG\_SURFACE Ra=1.14 ± 0.20um. 2.E JECTION MARK DEPTH 0.10 +0.05 3.ALL DIMENSIONS IN MILLIMETERS.



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